

## NiCd/NiMH Fast-Charge Management ICs

### Features

- Fast charge of nickel cadmium or nickel-metal hydride batteries
- Direct LED output displays charge status
- Fast-charge termination by  $-\Delta V$ , maximum voltage, maximum temperature, and maximum time
- Internal band-gap voltage reference
- Optional top-off charge
- Selectable pulse trickle charge rates
- Low-power mode
- 8-pin 300-mil DIP or 150-mil SOIC

### General Description

The bq2002 and bq2002/F Fast-Charge ICs are low-cost CMOS battery-charge controllers providing reliable charge termination for both NiCd and NiMH battery applications. Controlling a current-limited or constant-current supply allows the bq2002/F to be the basis for a cost-effective stand-alone or system-integrated charger. The bq2002/F integrates fast charge with optional top-off and pulsed-trickle control in a single IC for charging one or more NiCd or NiMH battery cells.

Fast charge is initiated on application of the charging supply or battery replacement. For safety, fast charge is inhibited if the battery temperature and voltage are outside configured limits.

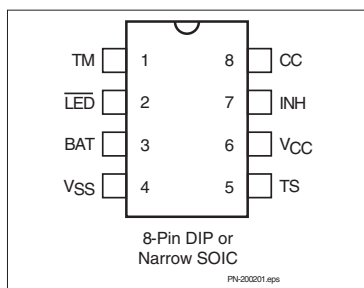
Fast charge is terminated by any of the following:

- Peak voltage detection (PVD)
- Negative delta voltage ( $-\Delta V$ )
- Maximum voltage
- Maximum temperature
- Maximum time

After fast charge, the bq2002/F optionally tops-off and pulse-trickles the battery per the pre-configured limits. Fast charge may be inhibited using the INH pin. The bq2002/F may also be placed in low-standby-power mode to reduce system power consumption.

The bq2002F differs from the bq2002 only in that a slightly different set of fast-charge and top-off time limits is available. All differences between the two ICs are illustrated in Table 1.

### Pin Connections



### Pin Names

TM	Timer mode select input	TS	Temperature sense input
LED	Charging status output	V <sub>CC</sub>	Supply voltage input
BAT	Battery voltage input	INH	Charge inhibit input
V <sub>SS</sub>	System ground	CC	Charge control output

### bq2002/F Selection Guide

Part No.	TCO	HTF	LTF	$-\Delta V$	PVD	Fast Charge	t <sub>MTO</sub>	Top-Off	Maintenance
bq2002	0.5 * V <sub>CC</sub>	None	None		✓	C/2	160	C/32	C/64
					✓	1C	80	C/16	C/64
				✓		2C	40	None	C/32
bq2002F	0.5 * V <sub>CC</sub>	None	None		✓	C/2	160	C/32	C/64
					✓	1C	100	C/16	C/64
				✓		2C	55	None	C/32

# bq2002/F

## Pin Descriptions

<b>TM</b>	<b>Timer mode input</b>
	A three-level input that controls the settings for the fast charge safety timer, voltage termination mode, top-off, pulse-trickle, and voltage hold-off time.
<b>LED</b>	<b>Charging output status</b>
	Open-drain output that indicates the charging status.
<b>BAT</b>	<b>Battery input voltage</b>
	The battery voltage sense input. The input to this pin is created by a high-impedance resistor divider network connected between the positive and negative terminals of the battery.
<b>VSS</b>	<b>System ground</b>
<b>TS</b>	<b>Temperature sense input</b>
	Input for an external battery temperature monitoring thermistor.
<b>VCC</b>	<b>Supply voltage input</b>
	5.0V $\pm$ 20% power input.
<b>INH</b>	<b>Charge inhibit input</b>
	When high, INH suspends the fast charge in progress. When returned low, the IC resumes operation at the point where initially suspended.

CC

**Charge control output**

An open-drain output used to control the charging current to the battery. CC switching to high impedance (Z) enables charging current to flow, and low to inhibit charging current. CC is modulated to provide top-off, if enabled, and pulse trickle.

## Functional Description

Figure 2 shows a state diagram and Figure 3 shows a block diagram of the bq2002/F.

## Battery Voltage and Temperature Measurements

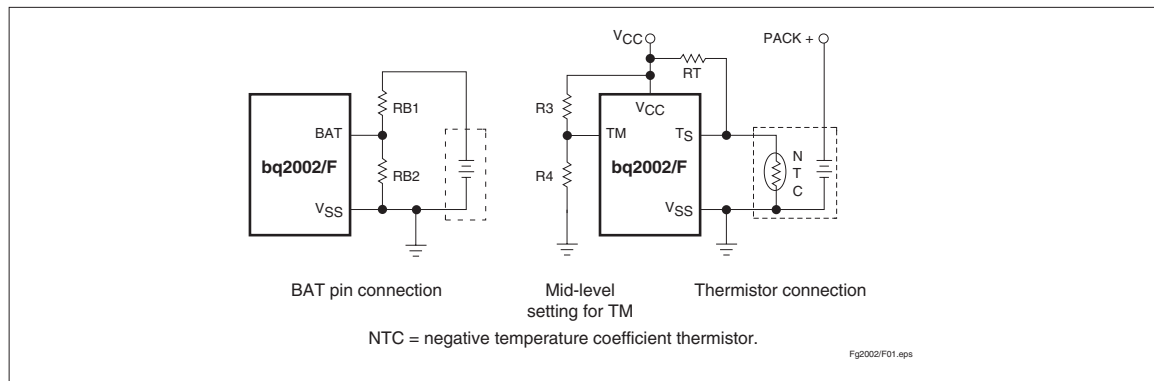
Battery voltage and temperature are monitored for maximum allowable values. The voltage presented on the battery sense input, BAT, should represent a single-cell potential for the battery under charge. A resistor-divider ratio of

$$\frac{RB1}{RB2} = N - 1$$

is recommended to maintain the battery voltage within the valid range, where N is the number of cells, RB1 is the resistor connected to the positive battery terminal, and RB2 is the resistor connected to the negative battery terminal. See Figure 1.

**Note:** This resistor-divider network input impedance to end-to-end should be at least 200k $\Omega$  and less than 1 M $\Omega$ .

A ground-referenced negative temperature coefficient thermistor placed near the battery may be used as a low-cost temperature-to-voltage transducer. The temperature sense voltage input at TS is developed using a resistor-thermistor network between VCC and VSS. See Figure 1.



**Figure 1. Voltage and Temperature Monitoring and TM Pin Configuration**

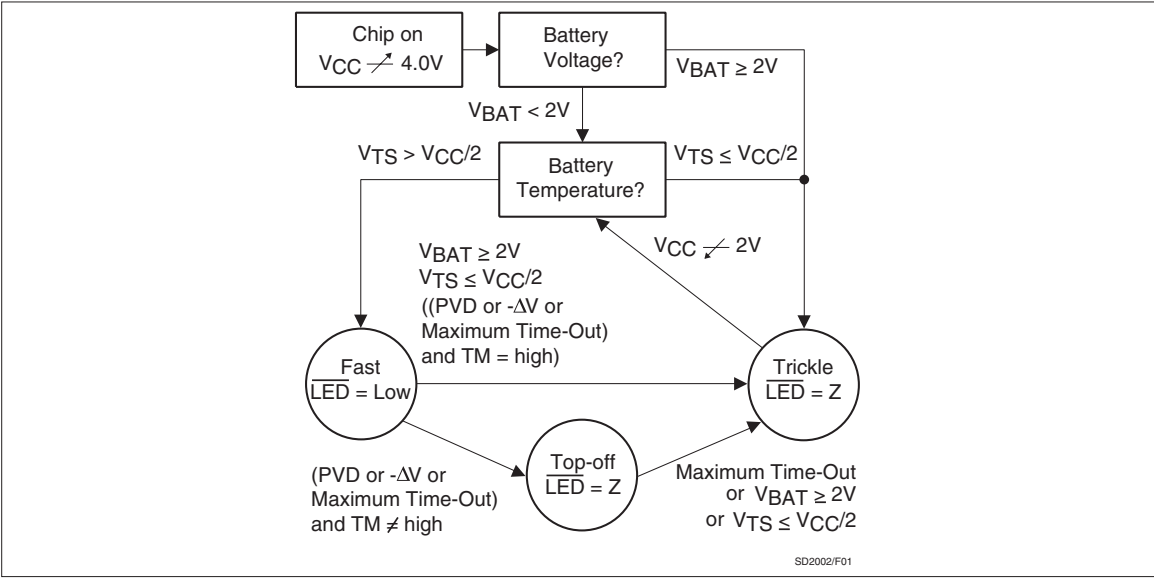


Figure 2. State Diagram

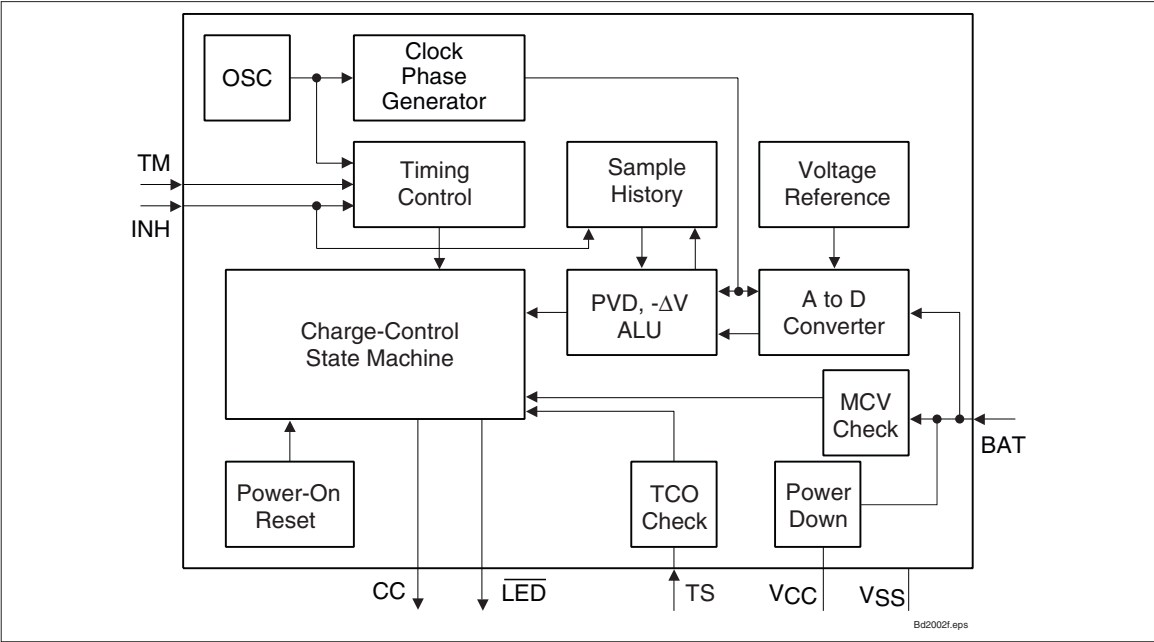
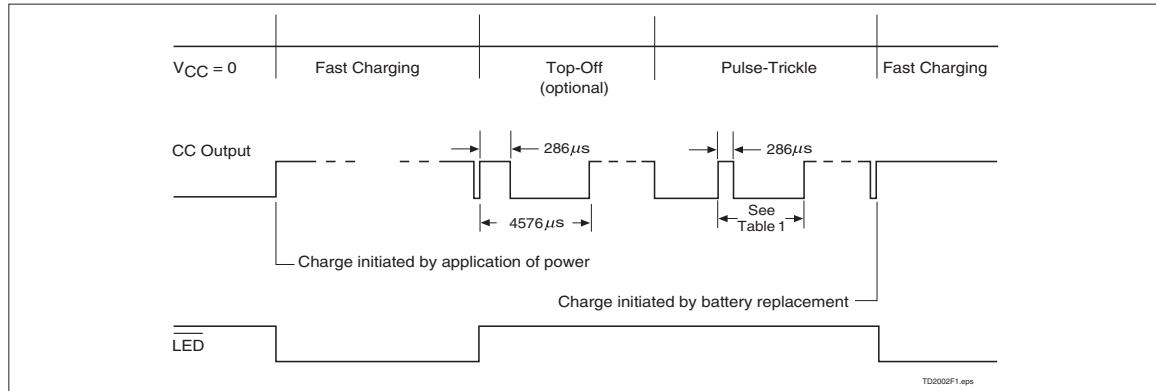


Figure 3. Block Diagram



**Figure 4. Charge Cycle Phases**

### Starting A Charge Cycle

Either of two events starts a charge cycle (see Figure 4):

1. Application of power to  $V_{CC}$  or
2. Voltage at the BAT pin falling through the maximum cell voltage  $V_{MCV}$  where

$$V_{MCV} = 2V \pm 5\%.$$

If the battery is within the configured temperature and voltage limits, the IC begins fast charge. The valid battery voltage range is  $V_{BAT} < V_{MCV}$ . The valid temperature range is  $V_{TS} > V_{TCO}$  where

$$V_{TCO} = 0.5 * V_{CC} \pm 5\%.$$

If the battery voltage or temperature is outside of these limits, the IC pulse-trickle charges until the next new charge cycle begins.

Fast charge continues until termination by one or more of the five possible termination conditions:

- Peak voltage detection (PVD)
- Negative delta voltage ( $-\Delta V$ )
- Maximum voltage
- Maximum temperature
- Maximum time

**Table 1. Fast-Charge Safety Time/Hold-Off Table**

Corresponding Fast-Charge Rate	TM	Termination	Typical Fast-Charge and Top-Off Time Limits (minutes)		Typical PVD and $-\Delta V$ Hold-Off Time (seconds)	Top-Off Rate	Pulse-Trickle Rate	Pulse-Trickle Period (ms)
			bq2002	bq2002F				
C/2	Mid	PVD	160	160	600	C/32	C/64	9.15
1C	Low	PVD	80	100	300	C/16	C/64	18.3
2C	High	$-\Delta V$	40	40	150	Disabled	C/32	18.3

**Notes:** Typical conditions = 25°C,  $V_{CC} = 5.0V$ .  
Mid =  $0.5 * V_{CC} \pm 5V$   
Tolerance on all timing is  $\pm 20\%$ .

## PVD and -ΔV Termination

There are two modes for voltage termination depending on the state of TM. For -ΔV (TM = high), if  $V_{BAT}$  is lower than any previously measured value by  $12\text{mV} \pm 3\text{mV}$ , fast charge is terminated. For PVD (TM = low or mid), a decrease of  $2.5\text{mV} \pm 2.5\text{mV}$  terminates fast charge. The PVD and -ΔV tests are valid in the range  $1\text{V} < V_{BAT} < 2\text{V}$ .

## Voltage Sampling

Voltage is sampled at the BAT pin for PVD and -ΔV termination once every 17s. The sample is an average of voltage measurements taken  $57\mu\text{s}$  apart. The IC takes 32 measurements in PVD mode and 16 measurements in -ΔV mode. The resulting sample periods (9.17 and 18.18ms, respectively) filter out harmonics centered around 55 and 109Hz. This technique minimizes the effect of any AC line ripple that may feed through the power supply from either 50 or 60Hz AC sources. Tolerance on all timing is  $\pm 20\%$ .

## Voltage Termination Hold-off

A hold-off period occurs at the start of fast charging. During the hold-off time, the PVD and -ΔV terminations are disabled. This avoids premature termination on the voltage spikes sometimes produced by older batteries when fast-charge current is first applied. Maximum voltage and temperature terminations are not affected by the hold-off period.

## Maximum Voltage, Temperature, and Time

Any time the voltage on the BAT pin exceeds the maximum cell voltage,  $V_{MCV}$ , fast charge or optional top-off charge is terminated.

Maximum temperature termination occurs anytime the voltage on the TS pin falls below the temperature cut-off threshold  $V_{TCO}$ .

Maximum charge time is configured using the TM pin. Time settings are available for corresponding charge rates of C/2, 1C, and 2C. Maximum time-out termination is enforced on the fast-charge phase, then reset, and enforced again on the top-off phase, if selected. There is no time limit on the trickle-charge phase.

## Top-off Charge

An optional top-off charge phase may be selected to follow fast charge termination for 1C and C/2 rates. This phase may be necessary on NiMH or other battery chemistries that have a tendency to terminate charge prior to reaching full capacity. With top-off enabled, charging continues at a reduced rate after fast-charge termination for a period of time selected by the TM pin. (See Table 1.) During top-off, the CC

pin is modulated at a duty cycle of  $286\mu\text{s}$  active for every  $4290\mu\text{s}$  inactive. This modulation results in an average rate 1/16th that of the fast charge rate. Maximum voltage, time, and temperature are the only termination methods enabled during top-off.

## Pulse-Trickle Charge

Pulse-trickle is used to compensate for self-discharge while the battery is idle in the charger. The battery is pulse-trickle charged by driving the CC pin active for a period of  $286\mu\text{s}$  for every 18.0ms of inactivity for 1C and 2C selections, and  $286\mu\text{s}$  for every 8.86ms of inactivity for C/2 selection. This results in a trickle rate of C/64 for the top-off enabled mode and C/32 otherwise.

## TM Pin

The TM pin is a three-level pin used to select the charge timer, top-off, voltage termination mode, trickle rate, and voltage hold-off period options. Table 1 describes the states selected by the TM pin. The mid-level selection input is developed by a resistor divider between  $V_{CC}$  and ground that fixes the voltage on TM at  $V_{CC}/2 \pm 0.5\text{V}$ . See Figure 4.

## Charge Status Indication

A fast charge in progress is uniquely indicated when the LED pin goes low. The LED pin is driven to the high-Z state for all conditions other than fast charge. Figure 2 outlines the state of the LED pin during charge.

## Charge Inhibit

Fast charge and top-off may be inhibited by using the INH pin. When high, INH suspends all fast charge and top-off activity and the internal charge timer. INH freezes the current state of LED until inhibit is removed. Temperature monitoring is not affected by the INH pin. During charge inhibit, the bq2002/F continues to pulse-trickle charge the battery per the TM selection. When INH returns low, charge control and the charge timer resume from the point where INH became active.

## Low-Power Mode

The IC enters a low-power state when  $V_{BAT}$  is driven above the power-down threshold ( $V_{PD}$ ) where

$$V_{PD} = V_{CC} - (1\text{V} \pm 0.5\text{V})$$

Both the CC pin and the LED pin are driven to the high-Z state. The operating current is reduced to less than  $1\mu\text{A}$  in this mode. When  $V_{BAT}$  returns to a value below  $V_{PD}$ , the IC pulse-trickle charges until the next new charge cycle begins.

## Absolute Maximum Ratings

Symbol	Parameter	Minimum	Maximum	Unit	Notes
V <sub>CC</sub>	V <sub>CC</sub> relative to V <sub>SS</sub>	-0.3	+7.0	V	
V <sub>T</sub>	DC voltage applied on any pin excluding V <sub>CC</sub> relative to V <sub>SS</sub>	-0.3	+7.0	V	
T <sub>OPR</sub>	Operating ambient temperature	0	+70	°C	Commercial
T <sub>STG</sub>	Storage temperature	-40	+85	°C	
T <sub>SOLDER</sub>	Soldering temperature	-	+260	°C	10 sec max.
T <sub>BIAS</sub>	Temperature under bias	-40	+85	°C	

**Note:** Permanent device damage may occur if **Absolute Maximum Ratings** are exceeded. Functional operation should be limited to the Recommended DC Operating Conditions detailed in this data sheet. Exposure to conditions beyond the operational limits for extended periods of time may affect device reliability.

## DC Thresholds (T<sub>A</sub> = 0 to 70°C; V<sub>CC</sub> ±20%)

Symbol	Parameter	Rating	Tolerance	Unit	Notes
V <sub>TCO</sub>	Temperature cutoff	0.5 * V <sub>CC</sub>	±5%	V	V <sub>TS</sub> ≤ V <sub>TCO</sub> inhibits/terminates fast charge and top-off
V <sub>MCV</sub>	Maximum cell voltage	2	±5%	V	V <sub>BAT</sub> ≥ V <sub>MCV</sub> inhibits/terminates fast charge and top-off
-ΔV	BAT input change for -ΔV detection	-12	±3	mV	
PVD	BAT input change for PVD detection	-2.5	±2.5	mV	

**Recommended DC Operating Conditions** ( $T_A = 0$  to  $70^\circ\text{C}$ )

Symbol	Condition	Minimum	Typical	Maximum	Unit	Notes
$V_{CC}$	Supply voltage	4.0	5.0	6.0	V	
$V_{DET}$	$-\Delta V$ , PVD detect voltage	1	-	2	V	
$V_{BAT}$	Battery input	0	-	$V_{CC}$	V	
$V_{TS}$	Thermistor input	0.5	-	$V_{CC}$	V	$V_{TS} < 0.5\text{V}$ prohibited
$V_{IH}$	Logic input high	0.5	-	-	V	INH
	Logic input high	$V_{CC} - 0.5$	-	-	V	TM
$V_{IM}$	Logic input mid	$\frac{V_{CC}}{2} - 0.5$	-	$\frac{V_{CC}}{2} + 0.5$	V	TM
$V_{IL}$	Logic input low	-	-	0.1	V	INH
	Logic input low	-	-	0.5	V	TM
$V_{OL}$	Logic output low	-	-	0.8	V	$\overline{\text{LED}}$ , CC, $I_{OL} = 10\text{mA}$
$V_{PD}$	Power down	$V_{CC} - 1.5$	-	$V_{CC} - 0.5$	V	$V_{BAT} \geq V_{PD}$ max. powers down bq2002/F; $V_{BAT} < V_{PD}$ min. = normal operation.
$I_{CC}$	Supply current	-	-	250	$\mu\text{A}$	Outputs unloaded, $V_{CC} = 5.1\text{V}$
$I_{SB}$	Standby current	-	-	1	$\mu\text{A}$	$V_{CC} = 5.1\text{V}$ , $V_{BAT} = V_{PD}$
$I_{OL}$	$\overline{\text{LED}}$ , CC sink	10	-	-	mA	@ $V_{OL} = V_{SS} + 0.8\text{V}$
$I_L$	Input leakage	-	-	$\pm 1$	$\mu\text{A}$	INH, CC, $V = V_{SS}$ to $V_{CC}$
$I_{OZ}$	Output leakage in high-Z state	-5	-	-	$\mu\text{A}$	$\overline{\text{LED}}$ , CC

**Note:** All voltages relative to  $V_{SS}$ .

## bq2002/F

---

### Impedance

Symbol	Parameter	Minimum	Typical	Maximum	Unit
R <sub>BAT</sub>	Battery input impedance	50	-	-	MΩ
R <sub>TS</sub>	TS input impedance	50	-	-	MΩ

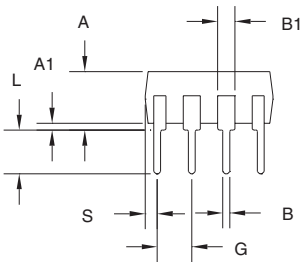
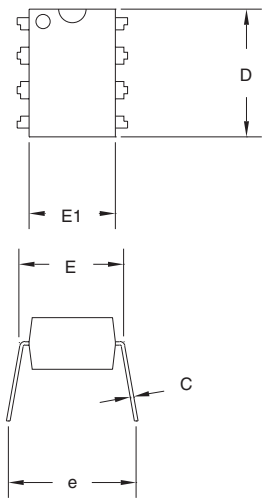
### Timing (T<sub>A</sub> = 0 to +70°C; V<sub>CC</sub> ±10%)

Symbol	Parameter	Minimum	Typical	Maximum	Unit	Notes
d <sub>FCV</sub>	Base time variation	-20	-	20	%	

**Note:** Typical is at T<sub>A</sub> = 25°C, V<sub>CC</sub> = 5.0V.



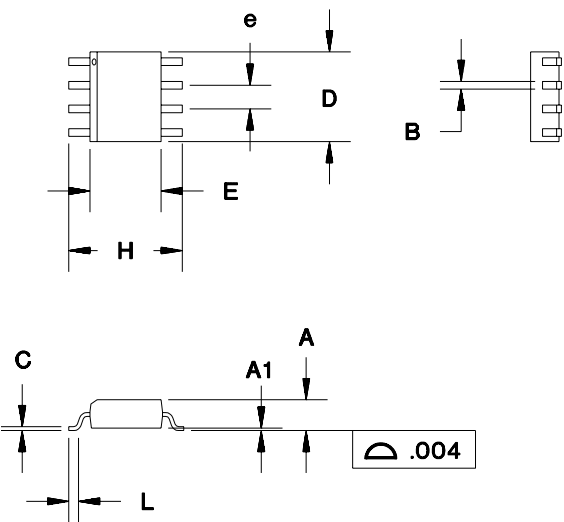
8-Pin DIP (PN)



8-Pin PN (0.300" DIP)

Dimension	Inches		Millimeters	
	Min.	Max.	Min.	Max.
A	0.160	0.180	4.06	4.57
A1	0.015	0.040	0.38	1.02
B	0.015	0.022	0.38	0.56
B1	0.055	0.065	1.40	1.65
C	0.008	0.013	0.20	0.33
D	0.350	0.380	8.89	9.65
E	0.300	0.325	7.62	8.26
E1	0.230	0.280	5.84	7.11
e	0.300	0.370	7.62	9.40
G	0.090	0.110	2.29	2.79
L	0.115	0.150	2.92	3.81
S	0.020	0.040	0.51	1.02

8-Pin SOIC Narrow (SN)



8-Pin SN (0.150" SOIC)

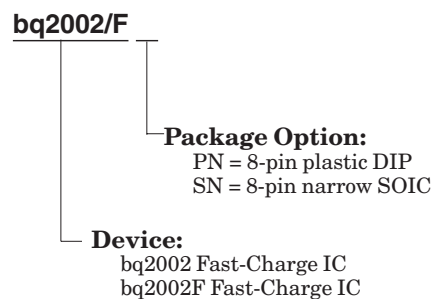
Dimension	Inches		Millimeters	
	Min.	Max.	Min.	Max.
A	0.060	0.070	1.52	1.78
A1	0.004	0.010	0.10	0.25
B	0.013	0.020	0.33	0.51
C	0.007	0.010	0.18	0.25
D	0.185	0.200	4.70	5.08
E	0.150	0.160	3.81	4.06
e	0.045	0.055	1.14	1.40
H	0.225	0.245	5.72	6.22
L	0.015	0.035	0.38	0.89

## Data Sheet Revision History

Change No.	Page No.	Description	Nature of Change
1	3	Was: Table 1 gave the bq2002/F Operational Summary. Is: Figure 2 gives the bq2002/F Operational Summary.	Changed table to figure.
1	5	Added Termination column to table and Top-off values.	Added column and values.
2	All	Revised and expanded this data sheet to include bq2002F	
3	1	Addition of selection guide	

**Notes:** Change 1 = Sept. 1996 B changes from July 1994.  
Change 2 = Aug. 1997 C changes from Sept. 1996 B.  
Change 3 = Jan. 1999 D changes from Aug. 1997 C.

## Ordering Information



## PACKAGING INFORMATION

Orderable Device	Status <sup>(1)</sup>	Package Type	Package Drawing	Pins	Package Qty	Eco Plan <sup>(2)</sup>	Lead/Ball Finish	MSL Peak Temp <sup>(3)</sup>
BQ2002FPN	ACTIVE	PDIP	P	8	50	Pb-Free (RoHS)	CU NIPDAU	Level-NC-NC-NC
BQ2002FPNE4	ACTIVE	PDIP	P	8	50	Pb-Free (RoHS)	CU NIPDAU	Level-NC-NC-NC
BQ2002FSN	ACTIVE	SOIC	D	8	75	Pb-Free (RoHS)	CU NIPDAU	Level-2-260C-1YEAR/ Level-1-220C-UNLIM
BQ2002FSNTR	ACTIVE	SOIC	D	8	2500	Pb-Free (RoHS)	CU NIPDAU	Level-2-260C-1YEAR/ Level-1-220C-UNLIM
BQ2002PN	ACTIVE	PDIP	P	8	50	Pb-Free (RoHS)	CU NIPDAU	Level-NC-NC-NC
BQ2002PNE4	ACTIVE	PDIP	P	8	50	Pb-Free (RoHS)	CU NIPDAU	Level-NC-NC-NC
BQ2002SN	ACTIVE	SOIC	D	8	75	Pb-Free (RoHS)	CU NIPDAU	Level-2-260C-1YEAR/ Level-1-220C-UNLIM
BQ2002SNTR	ACTIVE	SOIC	D	8	2500	Pb-Free (RoHS)	CU NIPDAU	Level-2-260C-1YEAR/ Level-1-220C-UNLIM

<sup>(1)</sup> The marketing status values are defined as follows:

**ACTIVE:** Product device recommended for new designs.

**LIFEBUY:** TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

**NRND:** Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

**PREVIEW:** Device has been announced but is not in production. Samples may or may not be available.

**OBSOLETE:** TI has discontinued the production of the device.

<sup>(2)</sup> Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS) or Green (RoHS & no Sb/Br) - please check <http://www.ti.com/productcontent> for the latest availability information and additional product content details.

**TBD:** The Pb-Free/Green conversion plan has not been defined.

**Pb-Free (RoHS):** TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

**Green (RoHS & no Sb/Br):** TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

<sup>(3)</sup> MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

**Important Information and Disclaimer:** The information provided on this page represents TI's knowledge and belief as of the date that it is provided. TI bases its knowledge and belief on information provided by third parties, and makes no representation or warranty as to the accuracy of such information. Efforts are underway to better integrate information from third parties. TI has taken and continues to take reasonable steps to provide representative and accurate information but may not have conducted destructive testing or chemical analysis on incoming materials and chemicals. TI and TI suppliers consider certain information to be proprietary, and thus CAS numbers and other limited information may not be available for release.

In no event shall TI's liability arising out of such information exceed the total purchase price of the TI part(s) at issue in this document sold by TI to Customer on an annual basis.

## IMPORTANT NOTICE

Texas Instruments Incorporated and its subsidiaries (TI) reserve the right to make corrections, modifications, enhancements, improvements, and other changes to its products and services at any time and to discontinue any product or service without notice. Customers should obtain the latest relevant information before placing orders and should verify that such information is current and complete. All products are sold subject to TI's terms and conditions of sale supplied at the time of order acknowledgment.

TI warrants performance of its hardware products to the specifications applicable at the time of sale in accordance with TI's standard warranty. Testing and other quality control techniques are used to the extent TI deems necessary to support this warranty. Except where mandated by government requirements, testing of all parameters of each product is not necessarily performed.

TI assumes no liability for applications assistance or customer product design. Customers are responsible for their products and applications using TI components. To minimize the risks associated with customer products and applications, customers should provide adequate design and operating safeguards.

TI does not warrant or represent that any license, either express or implied, is granted under any TI patent right, copyright, mask work right, or other TI intellectual property right relating to any combination, machine, or process in which TI products or services are used. Information published by TI regarding third-party products or services does not constitute a license from TI to use such products or services or a warranty or endorsement thereof. Use of such information may require a license from a third party under the patents or other intellectual property of the third party, or a license from TI under the patents or other intellectual property of TI.

Reproduction of information in TI data books or data sheets is permissible only if reproduction is without alteration and is accompanied by all associated warranties, conditions, limitations, and notices. Reproduction of this information with alteration is an unfair and deceptive business practice. TI is not responsible or liable for such altered documentation.

Resale of TI products or services with statements different from or beyond the parameters stated by TI for that product or service voids all express and any implied warranties for the associated TI product or service and is an unfair and deceptive business practice. TI is not responsible or liable for any such statements.

Following are URLs where you can obtain information on other Texas Instruments products and application solutions:

<b>Products</b>		<b>Applications</b>	
Amplifiers	<a href="http://amplifier.ti.com">amplifier.ti.com</a>	Audio	<a href="http://www.ti.com/audio">www.ti.com/audio</a>
Data Converters	<a href="http://dataconverter.ti.com">dataconverter.ti.com</a>	Automotive	<a href="http://www.ti.com/automotive">www.ti.com/automotive</a>
DSP	<a href="http://dsp.ti.com">dsp.ti.com</a>	Broadband	<a href="http://www.ti.com/broadband">www.ti.com/broadband</a>
Interface	<a href="http://interface.ti.com">interface.ti.com</a>	Digital Control	<a href="http://www.ti.com/digitalcontrol">www.ti.com/digitalcontrol</a>
Logic	<a href="http://logic.ti.com">logic.ti.com</a>	Military	<a href="http://www.ti.com/military">www.ti.com/military</a>
Power Mgmt	<a href="http://power.ti.com">power.ti.com</a>	Optical Networking	<a href="http://www.ti.com/opticalnetwork">www.ti.com/opticalnetwork</a>
Microcontrollers	<a href="http://microcontroller.ti.com">microcontroller.ti.com</a>	Security	<a href="http://www.ti.com/security">www.ti.com/security</a>
		Telephony	<a href="http://www.ti.com/telephony">www.ti.com/telephony</a>
		Video & Imaging	<a href="http://www.ti.com/video">www.ti.com/video</a>
		Wireless	<a href="http://www.ti.com/wireless">www.ti.com/wireless</a>

Mailing Address: Texas Instruments  
Post Office Box 655303 Dallas, Texas 75265

Copyright © 2005, Texas Instruments Incorporated